

# BFS17S

### **NPN Silicon RF Transistor**

- For broadband amplifiers up to 1 GHz at collector currents from 1 mA to 20 mA
- BFS17S: For orientation in reel see package information below
- Pb-free (RoHS compliant) package





ESD (Electrostatic discharge) sensitive device, observe handling precaution!

Туре	Marking	Pin Configuration					Package	
BFS17S	MCs	1=B1	2=E1	3=C2	4=B2	5=E2	6=C1	SOT363

### **Maximum Ratings** at $T_A$ = 25 °C, unless otherwise specified

Parameter	Symbol	Value	Unit
Collector-emitter voltage	V <sub>CEO</sub>	15	V
Collector-base voltage	V <sub>CBO</sub>	25	
Emitter-base voltage	V <sub>EBO</sub>	2.5	
Collector current	I <sub>C</sub>	25	mA
Peak collector current, $f = 10 \text{ MHz}$	I <sub>CM</sub>	50	
Total power dissipation <sup>1)</sup>	P <sub>tot</sub>	280	mW
<i>T</i> <sub>S</sub> ≤ 93 °C			
Junction temperature	TJ	150	°C
Ambient temperature	T <sub>A</sub>	-65 150	
Storage temperature	T <sub>Stg</sub>	-65 150	

#### Thermal Resistance

Parameter	Symbol	Value	Unit
Junction - soldering point <sup>2)</sup>	R <sub>thJS</sub>	≤ <b>240</b>	K/W

 $^{1}T_{S}$  is measured on the collector lead at the soldering point to the pcb

<sup>2</sup>For calculation of  $R_{\text{thJA}}$  please refer to Application Note AN077 (Thermal Resistance Calculation)



Parameter	Symbol	Values		Unit		
		min.	typ.	max.		
DC Characteristics						
Collector-emitter breakdown voltage	V <sub>(BR)CEO</sub>	15	-	-	V	
$I_{\rm C}$ = 1 mA, $I_{\rm B}$ = 0						
Collector-base cutoff current	I <sub>CBO</sub>				μA	
V <sub>CB</sub> = 10 V, <i>I</i> <sub>E</sub> = 0		-	-	0.05		
$V_{\rm CB} = 25  \text{V},  I_{\rm E} = 0$		-	-	10		
Emitter-base cutoff current	I <sub>EBO</sub>	-	-	100		
$V_{\rm EB}$ = 2.5 V, $I_{\rm C}$ = 0						
DC current gain	h <sub>FE</sub>				-	
$I_{\rm C}$ = 2 mA, $V_{\rm CE}$ = 1 V, pulse measured		40	-	150		
$I_{\rm C}$ = 25 mA, $V_{\rm CE}$ = 1 V, pulse measured		20	70	-		
Collector-emitter saturation voltage	V <sub>CEsat</sub>	-	0.1	0.4	V	
I <sub>C</sub> = 10 mA, I <sub>B</sub> = 1 mA						

# **Electrical Characteristics** at $T_A = 25^{\circ}$ C, unless otherwise specified



Parameter	Symbol	Values		Unit			
		min.	typ.	max.			
AC Characteristics (verified by random sampling)							
Transition frequency	f <sub>T</sub>				GHz		
<i>I</i> <sub>C</sub> = 2 mA, <i>V</i> <sub>CE</sub> = 5 V, <i>f</i> = 200 MHz		1	1.4	-			
$I_{\rm C}$ = 25 mA, $V_{\rm CE}$ = 5 V, $f$ = 200 MHz		1.3	2.5	-			
Collector-base capacitance	C <sub>cb</sub>	-	0.55	0.8	pF		
$V_{\rm CB}$ = 5 V, f = 1 MHz, $V_{\rm BE}$ = 0 ,							
emitter grounded							
Collector emitter capacitance	C <sub>ce</sub>	-	0.2	-			
$V_{CE} = 5 \text{ V}, f = 1 \text{ MHz}, V_{BE} = 0$ ,							
base grounded							
Emitter-base capacitance	C <sub>eb</sub>	-	0.9	1.45			
$V_{\rm EB}$ = 0.5 V, f = 1 MHz, $V_{\rm CB}$ = 0 ,							
collector grounded							
Minimum noise figure	NF <sub>min</sub>	-	3	5	dB		
$I_{\rm C}$ = 2 mA, $V_{\rm CE}$ = 5 V, $Z_{\rm S}$ = 50 $\Omega$ ,							
<i>f</i> = 800 MHz							
Transducer gain	S <sub>21e</sub>   <sup>2</sup>	-	14	-	dB		
$I_{\rm C}$ = 20 mA, $V_{\rm CE}$ = 5 V, $Z_{\rm S}$ = $Z_{\rm L}$ = 50 $\Omega$ ,							
<i>f</i> = 500 MHz							
Third order intercept point at output	IP <sub>3</sub>	-	22.5	-	dBm		
V <sub>CE</sub> = 5 V, <i>I</i> <sub>C</sub> = 20 mA, <i>f</i> = 800 MHz,							
$Z_{\rm S} = Z_{\rm Sopt}, Z_{\rm L} = Z_{\rm Lopt}$							
1dB compression point	P <sub>-1dB</sub>	-	11	-	-		
$I_{\rm C}$ = 20 mA, $V_{\rm CE}$ = 5 V, $Z_{\rm S}$ = $Z_{\rm L}$ = 50 $\Omega$ ,							
<i>f</i> = 800 MHz							

# **Electrical Characteristics** at $T_A = 25^{\circ}$ C, unless otherwise specified



BFS17S

## Total power dissipation $P_{tot} = f(T_S)$

**Permissible Pulse Load**  $R_{\text{thJS}} = f(t_p)$ 



### Permissible Pulse Load

 $P_{\text{totmax}}/P_{\text{totDC}} = f(t_{\text{p}})$ 





Collector-base capacitance  $C_{cb} = f(V_{CB})$ Emitter-base capacitance  $C_{eb} = f(V_{EB})$ f = 1 MHz





# BFS17S

# Transition frequency $f_{\rm T}$ = $f(I_{\rm C})$

 $V_{CE}$  = parameter







## Marking Layout (Example)

Small variations in positioning of Date code, Type code and Manufacture are possible.



## Standard Packing

Reel ø180 mm = 3.000 Pieces/Reel Reel ø330 mm = 10.000 Pieces/Reel

For symmetric types no defined Pin 1 orientation in reel.







Edition 2009-11-16

Published by Infineon Technologies AG 81726 Munich, Germany

© 2009 Infineon Technologies AG All Rights Reserved.

### Legal Disclaimer

The information given in this document shall in no event be regarded as a guarantee of conditions or characteristics. With respect to any examples or hints given herein, any typical values stated herein and/or any information regarding the application of the device, Infineon Technologies hereby disclaims any and all warranties and liabilities of any kind, including without limitation, warranties of non-infringement of intellectual property rights of any third party.

### Information

For further information on technology, delivery terms and conditions and prices, please contact the nearest Infineon Technologies Office (<<u>www.infineon.com</u>>).

### Warnings

Due to technical requirements, components may contain dangerous substances. For information on the types in question, please contact the nearest Infineon Technologies Office.

Infineon Technologies components may be used in life-support devices or systems only with the express written approval of Infineon Technologies, if a failure of such components can reasonably be expected to cause the failure of that life-support device or system or to affect the safety or effectiveness of that device or system. Life support devices or systems are intended to be implanted in the human body or to support and/or maintain and sustain and/or protect human life. If they fail, it is reasonable to assume that the health of the user or other persons may be endangered.



单击下面可查看定价,库存,交付和生命周期等信息

>>Infineon Technologies(英飞凌)

>>点击查看相关商品